

General Description

The MAX1570 fractional charge pump drives up to five white LEDs with regulated constant current for uniform intensity. The MAX1570 maintains the highest possible efficiency over the full 1-cell lithium-ion (Li+) battery input voltage range by utilizing a 1x/1.5x fractional charge pump and very-low-dropout current regulators. The MAX1570 operates with 1MHz fixed-frequency switching, allowing for tiny external components. The regulation scheme is optimized to ensure low EMI and low input ripple.

An external resistor sets the full-scale LED current. while two digital inputs control on/off and select between three levels of brightness. A pulse-width modulation (PWM) signal can also be used to modulate LED brightness.

The MAX1570 is available in 16-pin 4mm × 4mm Thin QFN packaging (0.8mm max height).

Applications

White LED Backlighting Cell Phones and Smart Phones PDA and Palmtop Computers Portable MP3 Players Digital Cameras and Camcorders

Features

- ♦ Excellent 0.3% LED-to-LED Current Matching
- ♦ 30mA/LED Drive Capability
- ♦ Proprietary 1x/1.5x Modes for Ultra-High **Efficiency**
- ♦ Low Input Ripple and EMI
- **♦** Eliminates Ballast Resistors
- ♦ Digital or PWM LED Dimming Control
- ♦ 0.1µA Shutdown Current
- ♦ 2.7V to 5.5V Supply Voltage Range
- **♦** Soft-Start Limits Inrush Current
- ♦ Thermal-Shutdown Protection
- ♦ No External Inductor, Schottky, or Zener Diode Required
- **♦ Tiny 16-Pin 4mm × 4mm Thin QFN Package**

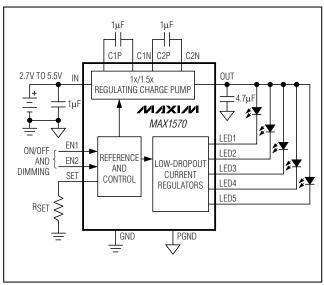
Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX1570ETE	-40°C to +85°C	16 Thin QFN

Pin Configuration

TOP VIEW 富 12 11 10 8 LED1 IN 13 7 LED2 C2P NIXIN MAX1570 OUT 15 : 6 LED3 16 5 LED4 C2N 3 ¦ Single THIN OFN 4mm x 4mm

Typical Operating Circuit



NIXIN

Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

IN, OUT, EN1, EN2 to GND	0.3V to +6V
SET, LED1, LED2, LED3, LED4,	
LED5 to GND	0.3V to $(V_{IN} + 0.3V)$
PGND to GND	0.3 to +0.3V
C1N, C2N to GND	0.3V to $(V_{IN} + 1V)$
C1P, C2P to GND	0.3V to the greater
$(V_{OUT} + 1V)$ or $(V_{IN} + 1V)$	
OUT Short Circuit to GND	Indefinite

Continuous Power Dissipation ($T_A = +70^{\circ}$)	
16-Pin Thin QFN (derate 16.9 mW/°C)	1349mW
Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{IN}=3.6V, GND=PGND=0, EN1=EN2=IN, C_{IN}=C1=C2=1\mu F, C_{OUT}=4.7\mu F, T_A=0^{\circ}C$ to +85°C, unless otherwise noted. Typical values are at $T_A=+25^{\circ}C$.)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
IN Operating Voltage		2.7		5.5	V
Undervoltage Lockout Threshold	V _{IN} rising or falling	2.25	2.45	2.60	V
Undervoltage Lockout Hysteresis			35		mV
Supply Current	1MHz switching, no load		2.0	3.5	mA
Shutdown Supply Current	EN1 = EN2 = GND		0.1	5	μΑ
Soft-Start Done Time			2.1		ms
	EN1 = GND, EN2 = IN, I _{SET} = 33µA	0.190	0.200	0.210	
SET Bias Voltage	EN1 = IN, EN2 = GND, I _{SET} = 67μA	0.380	0.400	0.420	V
	EN1 = IN, EN2 = IN, I _{SET} = 100μA	0.570	0.600	0.630	ĺ
SET Leakage in Shutdown	EN1 = EN2 = GND, V _{IN} = 5.5V, V _{SET} = 0 or 5.5V		0.01	1.00	μΑ
SET Current Range		20		130	μΑ
SET to LED_ Current Ratio	ILED/ISET, ISET = 67µA, VLED_= 1V	215	230	245	A/A
LED_ to LED_ Current Matching	I _{SET} = 67μA, V _{LED} = 1V	-3	0.3	+3	%
Maximum LED_ Sink Current	I _{SET} = 130µA, V _{LED} = 1V	28	30		mA
	I _{SET} = 33µA (Note 1)		100	180	
LED_ Dropout Voltage	I _{SET} = 67μA (Note 2)		200	360	mV
	I _{SET} = 100µA (Note 2)		230	410	
	EN1 = GND, EN2 = IN, ISET = 33µA	185	200	215	
LED1 Regulation Voltage (1.5x Mode)	EN1 = IN, EN2 = GND, I _{SET} = 67µA	277	300	323	mV
(1.5x Mode)	EN1 = IN, EN2 = IN, I _{SET} = 100μA	360	400	440	
LED Leakage in Shutdown	EN1 = GND, EN2 = GND, V _{LED} = 5.5V		0.01	1.00	μΑ
Maximum OUT Current	IN ≥ 3.4V, OUT ≥ 3.9V	150			mA
On an Loan Old Desistance	1x mode (V _{IN} - V _{OUT})/I _{OUT}		1.00	1.75	0
Open-Loop OUT Resistance	1.5x mode (1.5V _{IN} - V _{OUT})/I _{OUT}			8	Ω
Switching Frequency			1		MHz
EN1, EN2 High Voltage	IN = 2.7V to 5.5V	1.6			V
EN1, EN2 Low Voltage	IN = 2.7V to 5.5V			0.4	V
EN1, EN2 Input Current	EN_ = GND or 5.5V		0.01	1.00	μΑ

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{IN}=3.6V, GND=PGND=0, EN1=EN2=IN, C_{IN}=C1=C2=1\mu F, C_{OUT}=4.7\mu F, T_A=0^{\circ}C$ to +85°C, unless otherwise noted. Typical values are at $T_A=+25^{\circ}C$.)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
LED1 Dual Mode™ Threshold		50	75	100	mV
Thermal-Shutdown Threshold			160		°C
Thermal-Shutdown Hysteresis			20		°C

ELECTRICAL CHARACTERISTICS

 $(V_{IN}=3.6V, GND=PGND=0, EN1=EN2=IN, C_{IN}=C1=C2=1\mu F, C_{OUT}=4.7\mu F, T_A=-40^{\circ}C$ to +85°C, unless otherwise noted.) (Note 3)

PARAMETER	CONDITIONS	MIN	MAX	UNITS	
IN Operating Voltage		2.7	5.5	V	
Undervoltage Lockout Threshold	V _{IN} rising or falling	2.25	2.60	V	
Supply Current	1MHz switching, no load		3.5	mA	
Shutdown Supply Current	EN1 = EN2 = GND		5	μΑ	
	EN1 = GND, EN2 = IN, I _{SET} = 33μA	0.190	0.210		
SET Bias Voltage	EN1 = IN, EN2 = GND, I _{SET} = 67μA	0.380	0.420	V	
	EN1 = IN, EN2 = IN, I _{SET} = 100μA	0.570	0.630		
SET Leakage in Shutdown	EN1 = EN2 = GND, V _{IN} = 5.5V, V _{SET} = 0 or 5.5V		1	μΑ	
SET Current Range		20	130	μΑ	
SET to LED_ Current Ratio	I _{LED} /I _{SET} , I _{SET} = 67μA, V _{LED} = 1V	215	250	A/A	
LED_ to LED_ Current Matching	I _{SET} = 67µA, V _{LED} = 1V	-3	+3	%	
Maximum LED_ Sink Current	I _{SET} = 130μA, V _{LED} = 1V	28		mA	
	I _{SET} = 33µA (Note 1)		180		
LED_ Dropout Voltage	I _{SET} = 67µA (Note 2)		360	mV	
	I _{SET} = 100μA (Note 2)		410		
15545 13 14	EN1 = GND, EN2 = IN, I _{SET} = 33μA	185	215	Ì	
LED1 Regulation Voltage (1.5x Mode)	EN1 = IN, EN2 = GND, I _{SET} = 67μA	277	323	mV	
(1.5x Mode)	EN1 = IN, EN2 = IN, I _{SET} = 100μA	360	440		
LED Leakage in Shutdown	EN1 = GND, EN2 = GND, V _{LED} = 5.5V		1	μΑ	
Maximum OUT Current	IN ≥ 3.4V, OUT ≥ 3.9V	150		mA	
Ones Leen Old Decistores	1x mode (V _{IN} - V _{OUT})/I _{OUT}		1.75	0	
Open-Loop OUT Resistance	1.5x mode (1.5V _{IN} - V _{OUT})/I _{OUT}		8	Ω	
EN1, EN2 High Voltage	IN = 2.7V to 5.5V	1.6		V	
EN1, EN2 Low Voltage	IN = 2.7V to 5.5V		0.4	V	
EN1, EN2 Input Current	EN_ = GND or 5.5V		1	μΑ	
LED1 Dual Mode Threshold		50	100	mV	

Note 1: Dropout voltage is defined as the LED_ to GND voltage at which current sink into LED_ drops 20% from the value at LED_ = 1V.

Note 2: Dropout voltage is defined as the LED_ to GND voltage at which current sink into LED_ drops 10% from the value at LED_ = 1V.

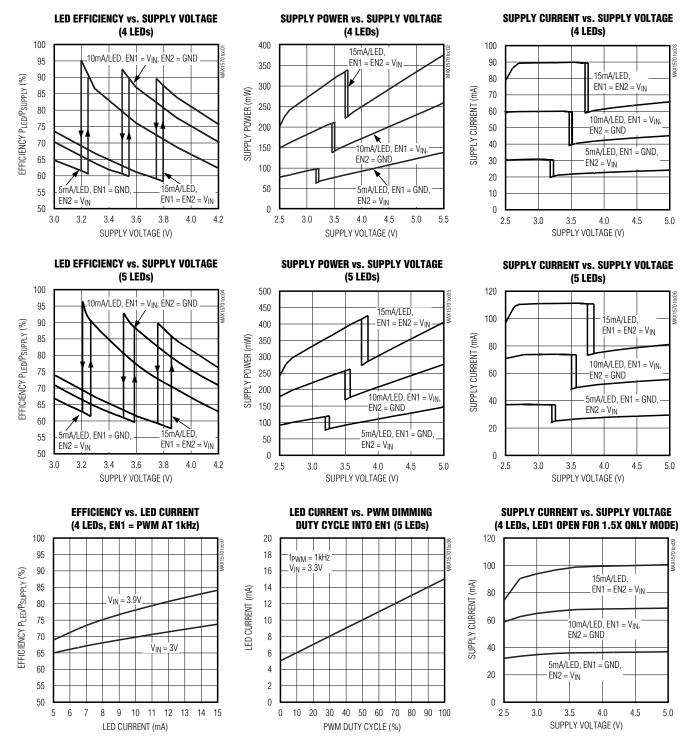
Note 3: Specifications to -40°C are guaranteed by design and not production tested.

Dual Mode is a trademark of Maxim Integrated Products, Inc.



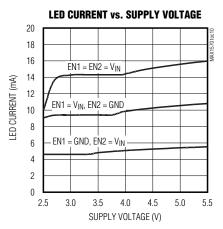
Typical Operating Characteristics

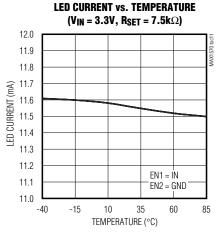
(EN1 = EN2 = IN, C_{IN} = 1 μ F, C1 = C2 = 1 μ F, C_{OUT} = 4.7 μ F, R_{SET} = 9.09 $k\Omega$, T_A = +25 $^{\circ}$ C, unless otherwise noted.)

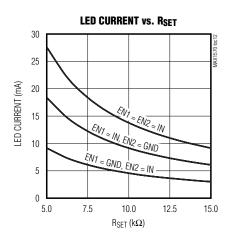


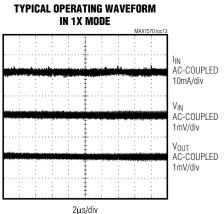
Typical Operating Characteristics (continued)

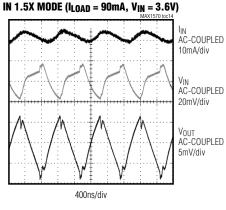
(EN1 = EN2 = IN, C_{IN} = 1 μ F, C1 = C2 = 1 μ F, C_{OUT} = 4.7 μ F, R_{SET} = 9.09 $k\Omega$, T_A = +25°C, unless otherwise noted.)



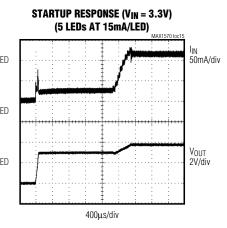


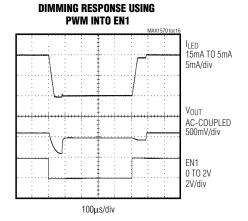


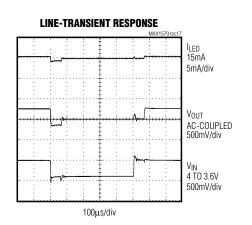




TYPICAL OPERATING WAVEFORM







Pin Description

PIN	NAME	FUNCTION
1	C1P	Transfer Capacitor 1 Positive Connection
2	EN2	Enable, Dimming Control Input 2. EN2 and EN1 control shutdown, 1/3 current, 2/3 current, and full current (see Table1).
3	GND	Analog Ground. Connect directly to the exposed paddle underneath the IC.
4	LED5	LED5 Cathode Connection. Current flowing into LED5 is 230 times the current flowing out of SET. When using fewer than five LEDs, this pin can be left unconnected. LED5 is high impedance during shutdown.
5	LED4	LED4 Cathode Connection. Current flowing into LED4 is 230 times the current flowing out of SET. When using fewer than five LEDs, this pin can be left unconnected. LED4 is high impedance during shutdown.
6	LED3	LED3 Cathode Connection. Current flowing into LED3 is 230 times the current flowing out of SET. When using fewer than five LEDs, this pin can be left unconnected. LED3 is high impedance during shutdown.
7	LED2	LED2 Cathode Connection. Current flowing into LED2 is 230 times the current flowing out of SET. When using fewer than five LEDs, this pin can be left unconnected. LED2 is high impedance during shutdown.
8	LED1	LED1 Cathode Connection and Charge-Pump Feedback. Current flowing into LED1 is 230 times the current flowing out of SET. The charge pump regulates the voltage on LED1 to various voltages depending upon the status of EN1 and EN2 (see Table 1). Grounding LED1 forces OUT to operate at 5V while LED2–LED5 regulate the LED current to 230 x V _{SET} /R _{SET} . LED1 is high impedance during shutdown.
9	SET	Bias Current Set Input. The current flowing out of SET programs the bias current into each LED by ILED_ = 230 x ISET. VSET is internally biased to various voltages (see Table 1). Connect a resistor to GND to set the bias current as VSET/RSET. SET is high impedance during shutdown.
10	EN1	Enable, Dimming Control Input 1. EN1 and EN2 control shutdown, 1/3 current, 2/3 current, and full current (see Table 1).
11	PGND	Power Ground. Charge-pump switching current flows through this pin. Connect to GND and system ground as close to the MAX1570 and the input bypass capacitor as possible.
12	C1N	Transfer Capacitor 1 Negative Connection
13	IN	Supply Voltage Input. Bypass IN to PGND with a 1µF ceramic capacitor. The input voltage range is 2.7V to 5.5V. IN is high impedance during shutdown.
14	C2P	Transfer Capacitor 2 Positive Connection
15	OUT	Charge-Pump Output. Bypass to PGND with a 4.7µF ceramic capacitor as close to the IC as possible. Connect to the anodes of all the LEDs. OUT is high impedance during shutdown.
16	C2N	Transfer Capacitor 2 Negative Connection
_	EP	Exposed paddle. Connect to GND.

Detailed Description

The MAX1570 is a complete charge-pump buck/boost converter requiring only four small ceramic capacitors. The MAX1570 utilizes a proprietary 1x/1.5x fractional charge-pump topology to drive up to five white LEDs with regulated constant current for uniform intensity. The MAX1570 operates with a 1MHz fixed frequency. An external resistor (RSET) programs the full-scale LED current, while two digital inputs control on/off and provide brightness control.

Output Regulation

The MAX1570 operates in 1x charge-pump mode until just above dropout. Then the MAX1570 switches to 1.5x charge-pump mode to regulate the voltage at LED1 and maintain constant LED brightness even at very low battery voltages. Using this topology, there is no LED brightness change during the 1x/1.5x switchover, which guarantees no flicker on the display. The switchover scheme has low hysteresis, minimizing operation in the less efficient 1.5x mode. The 1x mode produces almost no ripple, while the 1.5x mode regulates the output voltage by controlling the rate at which the transfer capacitors are charged. In this way, the switching frequency remains constant for reduced input ripple and stable noise spectrum.

Soft-Start

The MAX1570 includes soft-start circuitry to limit inrush current at turn-on. When starting up with an output voltage that is not near the input voltage, the output capacitor is charged directly from the input with a DAC ramped current source (with no charge-pump action) until the output voltage is near the input voltage. Once this occurs, the charge pump determines if 1x or 1.5x mode is required. In the case of 1x mode, the soft-start is terminated and normal operation begins. In the case of 1.5x mode, soft-start operates until LED1 reaches regulation. In case of an overload condition, soft-start repeats every 2.1ms. If the output is shorted to ground, the output current is limited by the MAX1570 fractional-switching technique and then the device hits thermal shutdown once the die temperature reaches -160°C.

True Shutdown Mode

When EN1 and EN2 are grounded, the MAX1570 is in shutdown, and the charge pump examines whether the input voltage is greater than or less than the output voltage and shorts the transfer capacitor nodes to either IN or OUT as necessary. The output is high impedance in either case.

Thermal Shutdown

The MAX1570 includes a thermal-limit circuit that shuts down the IC at about 160°C. Turn-on occurs after the IC cools by approximately 20°C.

Setting the Output Current

SET controls the LED bias current. Current flowing into LED1, LED2, LED3, LED4, and LED5 is 230 times greater than the current flowing out of SET. Set the output current as follows:

$$I_{LED} = 230 \times \left(\frac{V_{SET}}{R_{SET}}\right)$$

where $V_{SET} = 0.2V$, 0.4V, or 0.6V (depending upon EN1 and EN2, see Table 1), and R_{SET} is the resistor connected between SET and GND (see the *Typical Operating Circuit*).

_Applications Information

Dimming Using EN1 and EN2

Use EN1 and EN2 inputs as a digital 2-bit number to control on/off, 1/3, 2/3, and full current (see Table 1). EN1 and EN2 control the voltage at SET (VSET). Adjusting the SET voltage controls the current (ISET) through the SET resistor (RSET). Increasing VSET or reducing RSET increases ISET, which then increases the LED current (ILED).

The charge-pump feedback threshold at LED1 is increased as the current is increased to prevent dropout in the current regulators while improving efficiency at lower current settings. LED1 is regulated at 0.2V, 0.3V, or 0.4V when EN1 and EN2 are adjusted for 1/3, 2/3, or full current, respectively (see Table 1). A higher threshold improves LED-to-LED current matching, while a lower threshold improves efficiency by allowing the 1x mode at lower input voltages.

Dimming Using PWM into EN1

Use EN2 for shutdown and drive EN1 with a PWM signal. Current can be varied from 1/3 to full. The waveforms in the *Typical Operating Characteristics* show the response time of dimming. EN2 keeps the part on, eliminating any soft-start delay that would impede PWM control, allowing a PWM frequency up to 5kHz (Figure 1).

Dimming Using a Filtered-PWM Signal

Use a high-frequency PWM signal to drive an R-C-R filter on the SET pin (Figure 2). A 0% PWM duty cycle corresponds to 20mA/LED, while a 100% PWM duty cycle corresponds to 0mA/LED. At PWM frequencies above 5kHz, C3 may be reduced.

Table 1. Enable Input Modes

EN_ INPUT LOGIC LEVELS	MODE	LED CURRENT
EN1 = 0, EN2 = 0	Shutdown mode	0
EN1 = 0, EN2 = 1	On, V _{SET} = 200mV, LED1 threshold = 200mV	1/3
EN1 = 1, EN2 = 0	On, V _{SET} = 400mV, LED1 threshold = 300mV	2/3
EN1 = 1, EN2 = 1	On, V _{SET} = 600mV, LED1 threshold = 400mV	Full

Table 2. Capacitor Selection

OUTPUT (mA)	C _{IN} (µF)	C1 (μF)	C2 (μF)	C _{OUT} (µF)
40	1	0.22	0.22	4.7
80	1	0.47	0.47	4.7
150	1	1.0	1.0	4.7

Table 3. Capacitor Manufacturers

COMPONENT NAME	VALUE (μF)	MANUFACTURER	PART NO.	DESCRIPTION
CIN	C _{IN} 1 Taiyo Yuden		JMK107BJ105MA	1µF ±20%, 6.3V X5R ceramic capacitor (0603)
Cout	Cout 4.7 T		JMK212BJ475MG	4.7µF ±20%, 6.3V X5R ceramic capacitor (0805)
1		Taiyo Yuden	JMK107BJ105MA	1µF ±20%, 6.3V X5R ceramic capacitor (0603)
C1 and C2 0.4		Taiyo Yuden	LMK107BJ474MA	0.47µF ±20%, 10V X5R ceramic capacitor (0603)
	0.22	Taiyo Yuden	LMK107BJ224KA	0.22µF ±10%, 10V X7R ceramic capacitor (0603)

Input Ripple

For LED drivers, input ripple is more important than output ripple. Input ripple depends on the source supply's impedance. Adding a lowpass filter to the input further reduces input ripple. Figure 3 shows a C-R-C filter used to reduce input ripple to less than 2mV_{P-P} when driving a 75mA load. Alternately, increasing C_{IN} to 2.2µF or 4.7µF yields input ripple of 17mV_{P-P} or 9mV_{P-P}, respectively, with only a small increase in footprint. The 1x mode has very low input ripple.

PC Board Layout and Routing

The MAX1570 is a high-frequency switched-capacitor voltage regulator. For best circuit performance, use a solid ground plane and place C_{IN} and C_{OUT} as close to the MAX1570 as possible. Also, place their ground tails close together. Connect PGND and GND directly under the IC to the exposed paddle, and connect C_{IN} and C_{OUT} as close as possible to PGND. The input supply connections should be short; if this is not possible, an additional input supply filter capacitor (tantalum or electrolytic) may be required. Refer to the MAX1570 EV kit for a good layout example.

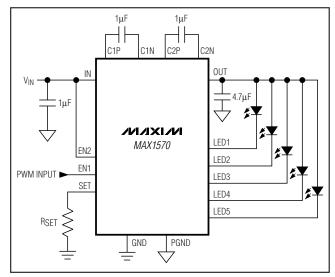


Figure 1. Dimming Using PWM Signal into EN1

Component Selection

Typical external component values are shown in Table 2 and Table 3.

Maximum power dissipation occurs around 4.2V on IN and 4.0V at OUT with maximum load current.

$$P_D = [((1.5 \times V_{IN}) - V_{OUT}) + 0.4V] \times 120mA = 324mW$$

At higher IN voltages this device switches to 1x mode and power dissipation is lowered.

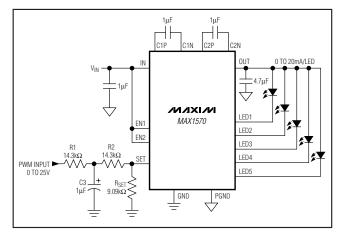


Figure 2. Dimming Using Filtered-PWM Signal

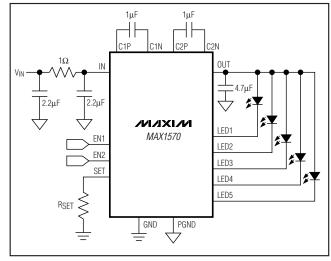


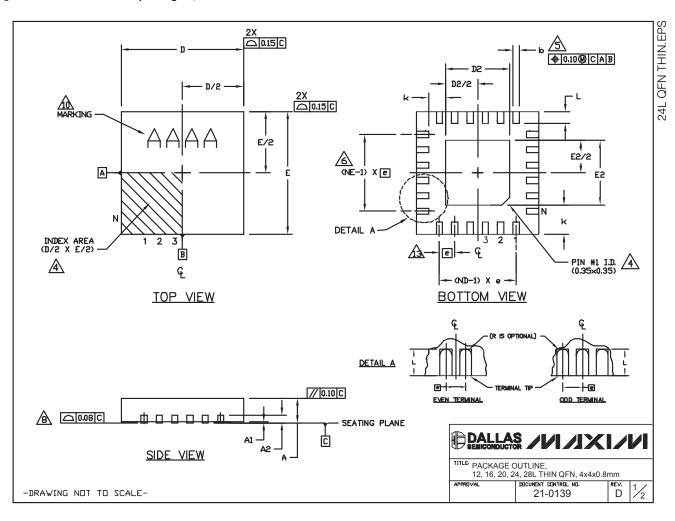
Figure 3. C-R-C Filter Reduces Input Ripple

Chip Information

TRANSISTOR COUNT: 3187

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)



Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)

	COMMON DIMENSIONS																			
PKG	KG 12L 4×4		16L 4×4		20L 4×4		24L 4×4		28L 4×4		:4									
REF.	MIN.	NDM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.					
Α	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80					
A1	0.0	0.02	0.05	0.0	0.02	0.05	0.0	0.02	0.05	0.0	0.02	0.05	0.0	0.02	0.05					
A2	(0.20 REF 0.20 REF 0.20 REF		0.20 REF		0.20 REF 0.20 REF		0	.20 RE	F										
b	0.25	0.30	0.35	0.25	0.30	0.35	0.20	0.25	0.30	0.18	0.23	0.30	0.15	0.20	0.25					
D	3,90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10					
Ε	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10					
6		0.80 BS	C.	0	65 BS	C.	0	0.50 BSC.		0.50 BSC.		0.50 BSC.		0.50 BSC.		0.50 BSC. 0.50 BSC.		C.	0.40 BSC.	
k	0.25	-	-	0.25	-	-	0.25	-	-	0.25	-	-	0.25	ı	-					
L	0.45	0.55	0.65	0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50	0.30	0.40	0.50					
N		12			16		20		20 24			28								
ND		3			4	4 5		5	6			7								
NE		3			4			5		6		7								
Jedec Var-	edec VGGB VGGC VGGD-1		1	WGGD-2 VGGE																

E	EXPOSED PAD VARIATIONS							
PKG.		D2			E2		DOWN	
CODES	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	ALLOVED	
T1244-2	1.95	2.10	2.25	1.95	2.10	2.25	ND	
T1244-3	1.95	2.10	2.25	1.95	2.10	2.25	YES	
T1244-4	1.95	2.10	2.25	1.95	2.10	2.25	ND	
T1644-2	1.95	2.10	2.25	1.95	2.10	2.25	ND	
T1644-3	1.95	2.10	2.25	1.95	2.10	2.25	YES	
T1644-4	1.95	2.10	2.25	1.95	2.10	2.25	ND	
T2044-1	1.95	2.10	2.25	1.95	2.10	2.25	ND	
T2044-2	1.95	2.10	2.25	1.95	2.10	2.25	YES	
T2044-3	1.95	2.10	2.25	1.95	2.10	2.25	ND	
T2444-1	2.45	2.60	2.63	2.45	2.60	2.63	ND	
T2444-2	1.95	2.10	2.25	1.95	2.10	2.25	YES	
T2444-3	2.45	2.60	2.63	2.45	2.60	2.63	YES	
T2444-4	2.45	2.60	2.63	2.45	2.60	2.63	ND	
T2844-1	2,50	2.60	2,70	2,50	2.60	2,70	ND	

NOTES:

- 1. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS, ANGLES ARE IN DEGREES.
- 3. N IS THE TOTAL NUMBER OF TERMINALS.
- THE TERMINAL \$1 DENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO

 JESD 95-1 SPP-012. DETAILS OF TERMINAL \$1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN

 THE ZONE INDICATED. THE TERMINAL \$1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.
- DIMENSION 6 APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 mm AND 0.30 mm FROM TERMINAL TIP.
- ⚠ ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
- DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.
- COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
- 9. DRAWING CONFORMS TO JEDEC MO22D, EXCEPT FOR T2444-1, T2444-3, T2444-4 AND T2844-1.
- MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.
- 11. COPLANARITY SHALL NOT EXCEED 0.08mm
- 12. WARPAGE SHALL NOT EXCEEND 0.10mm
- LEAD CENTERLINES TO BE AT TRUE POSITION AS DEFINED BY BASIC DIMENSION "6", ±0.05.



TITLE PACKAGE OUTLINE, 12, 16, 20, 24, 28L THIN QFN, 4x4x0.8mm

DOCUMENT CONTROL NO.

21-0139

D

-DRAWING NOT TO SCALE-

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.



OOO «ЛайфЭлектроникс" "LifeElectronics" LLC

ИНН 7805602321 КПП 780501001 P/C 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 3010181090000000703 БИК 044030703

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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